

HAT2037T

Silicon N Channel Power MOS FET
High Speed Power Switching

HITACHI

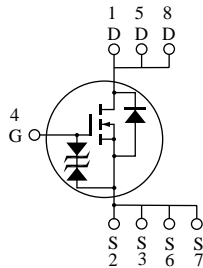
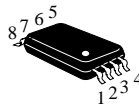
ADE-208-530 D (Z)
5th. Edition
February 1999

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline

TSSOP-8



1, 5, 8 Drain
2, 3, 6, 7 Source
4 Gate

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	28	V
Gate to source voltage	V_{GSS}	± 12	V
Drain current	I_D	5.5	A
Drain peak current	$I_{D(\text{pulse})}$ ^{Note1}	44	A
Body-drain diode reverse drain current	I_{DR}	5.5	A
Channel dissipation	Pch ^{Note2}	1.3	W
Channel temperature	Tch	150	$^\circ\text{C}$
Storage temperature	Tstg	-55 to +150	$^\circ\text{C}$

Note: 1. $PW \leq 10\mu\text{s}$, duty cycle $\leq 1\%$

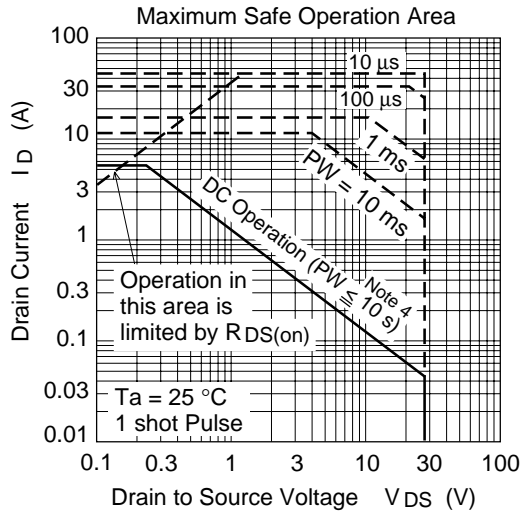
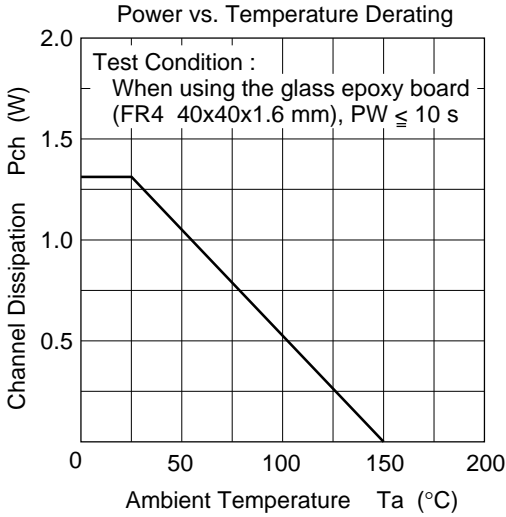
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10\text{s}$

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

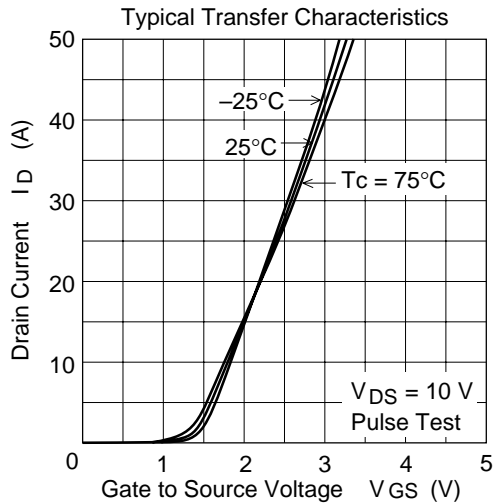
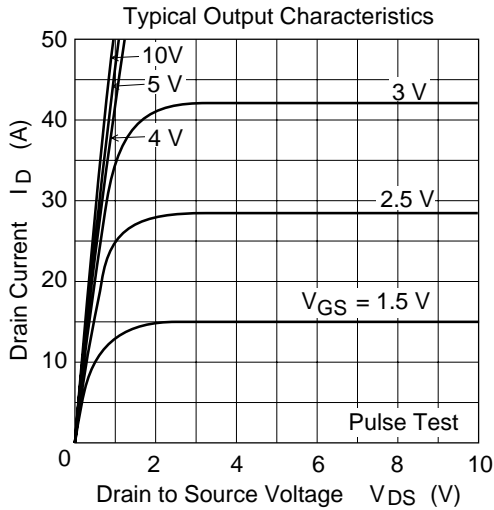
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	28	—	—	V	$I_D = 10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 12	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 10\text{V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 28\text{V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(\text{off})}$	0.4	—	1.4	V	$V_{DS} = 10\text{V}$, $I_D = 1\text{mA}$
Static drain to source on state resistance	$R_{DS(\text{on})}$	—	0.021	0.028	Ω	$I_D = 3\text{A}$, $V_{GS} = 4\text{V}$ ^{Note3}
	$R_{DS(\text{on})}$	—	0.027	0.038	Ω	$I_D = 3\text{A}$, $V_{GS} = 2.5\text{V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	9	14	—	S	$I_D = 3\text{A}$, $V_{DS} = 10\text{V}$ ^{Note3}
Input capacitance	Ciss	—	780	—	pF	$V_{DS} = 10\text{V}$
Output capacitance	Coss	—	470	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	190	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(\text{on})}$	—	20	—	ns	$V_{GS} = 4\text{V}$, $I_D = 3\text{A}$
Rise time	t_r	—	130	—	ns	$V_{DD} \approx 10\text{V}$
Turn-off delay time	$t_{d(\text{off})}$	—	155	—	ns	
Fall time	t_f	—	160	—	ns	
Body-drain diode forward voltage	V_{DF}	—	0.81	1.06	V	$IF = 5.5\text{A}$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	55	—	ns	$IF = 5.5\text{A}$, $V_{GS} = 0$ $diF/dt = 20\text{A}/\mu\text{s}$

Note: 3. Pulse test

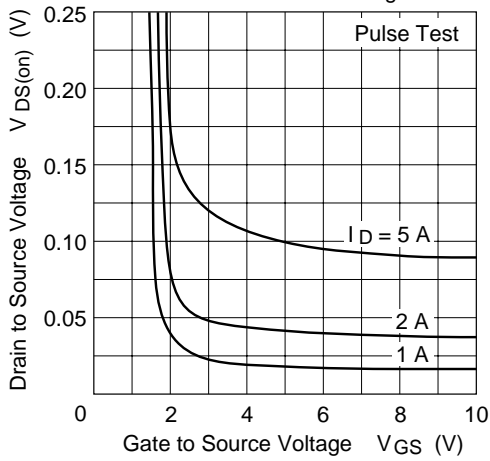
Main Characteristics



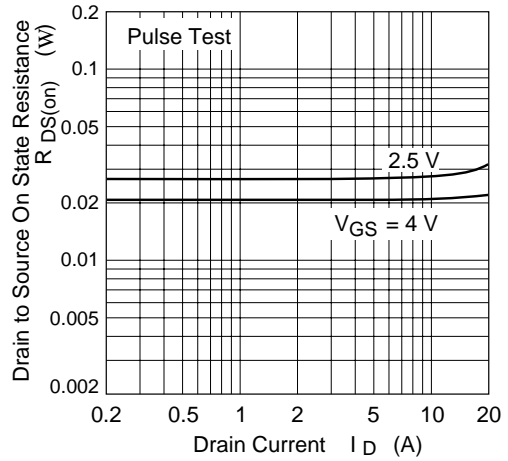
Note 4 :
When using the glass epoxy board (FR4 40x40x1.6 mm)



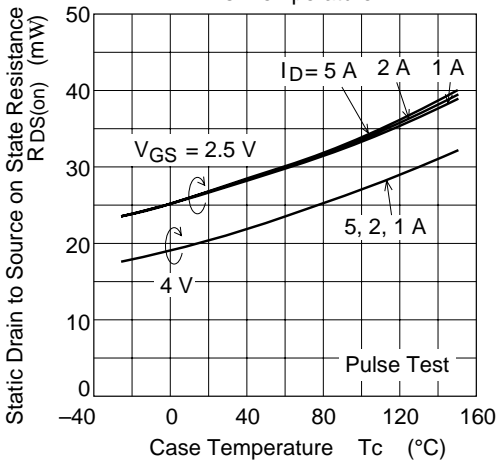
Drain to Source Saturation Voltage vs. Gate to Source Voltage



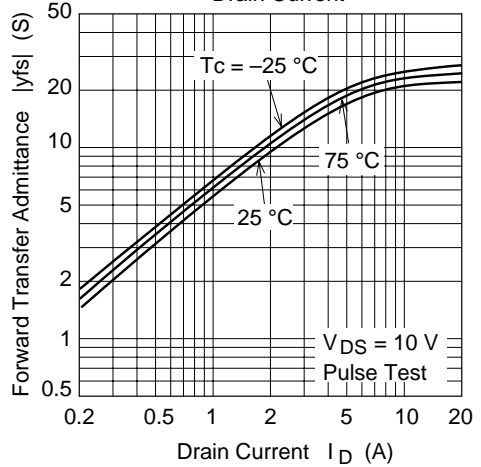
Static Drain to Source on State Resistance vs. Drain Current

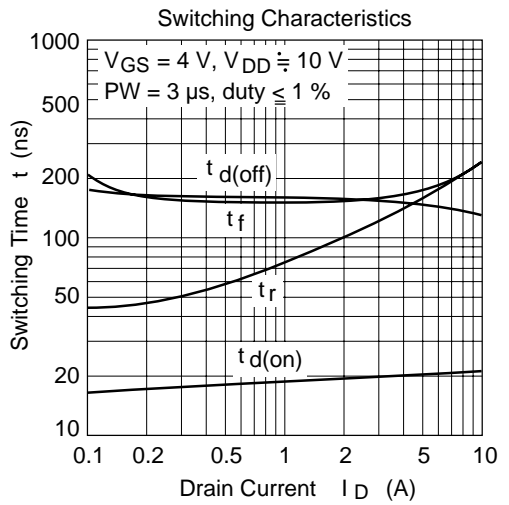
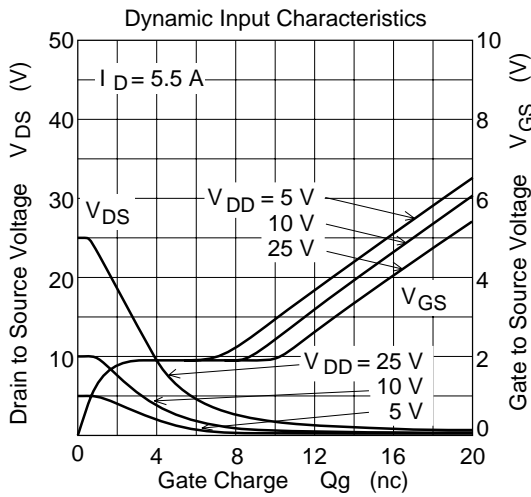
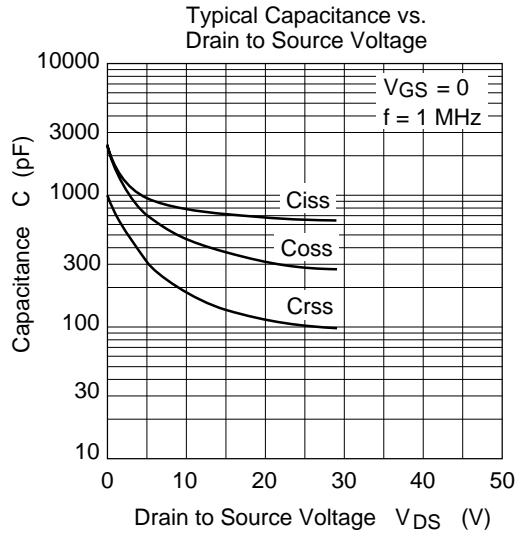
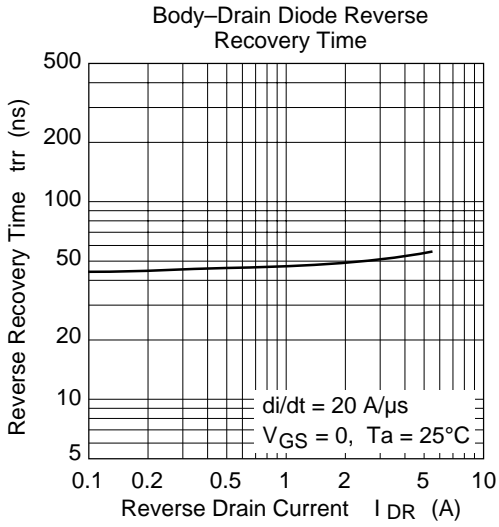


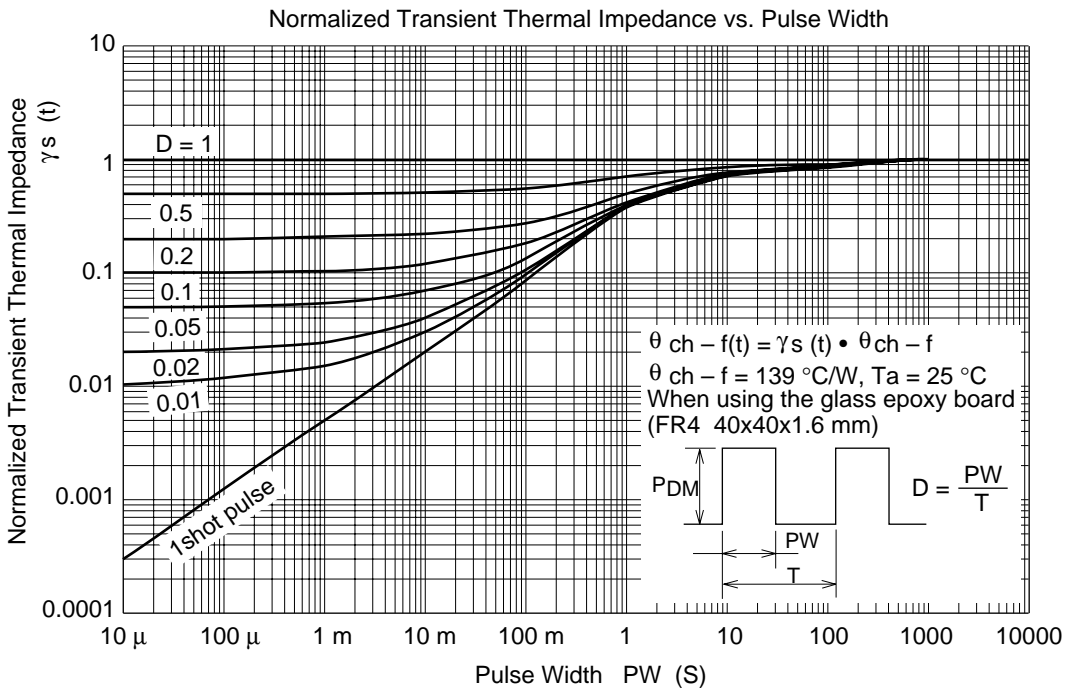
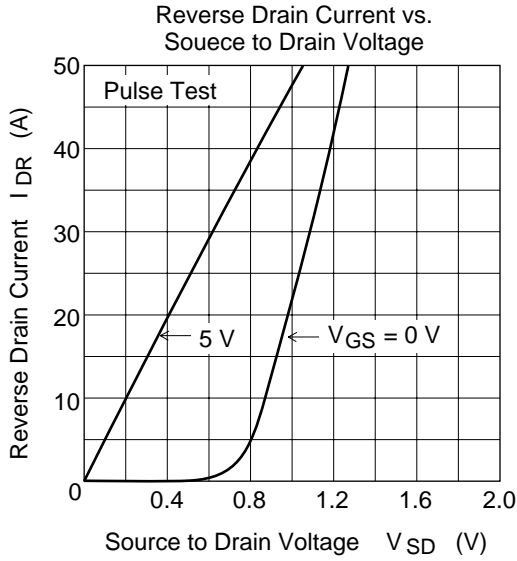
Static Drain to Source on State Resistance vs. Temperature



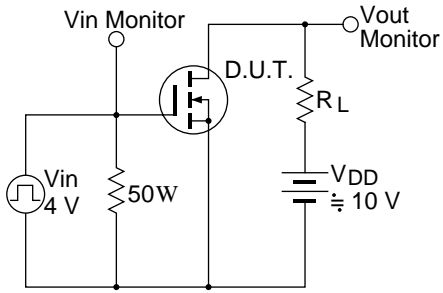
Forward Transfer Admittance vs. Drain Current



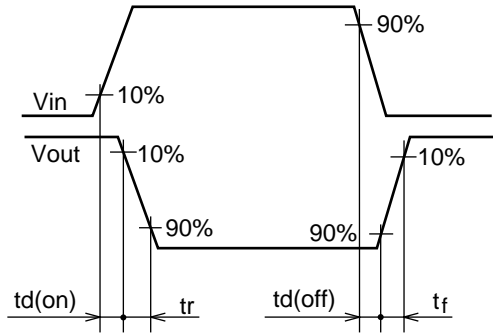




Switching Time Test Circuit

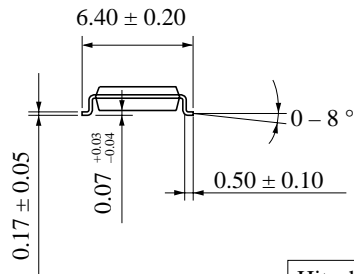
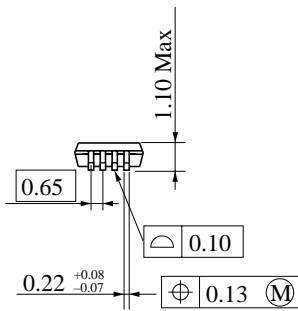
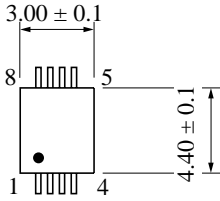


Switching Time Waveform



Package Dimensions

Unit: mm



Hitachi code	TTP-8D
EIAJ	—
JEDEC	—

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